



**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Application No.: 09/445,102  
Filing Date: 11/30/1999  
Applicant: Kenji Uchiyama  
Group Art Unit: 2871  
Examiner: Tai V. Duong  
Title: COMPRESSION-BOND CONNECTION SUBSTRATE,  
LIQUID CRYSTAL DEVICE, AND ELECTRONIC  
EQUIPMENT  
Attorney Docket: 9319S-000112

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Commissioner of Patents and Trademarks  
Washington, D.C. 20231

**AMENDMENT**

Sir:

In response to the Office Action mailed January 2, 2003, please amend  
the application as follows and consider the remarks set forth below.

**IN THE CLAIMS**

Please amend the claims in accordance with the following rewritten claims  
in clean form. Applicant includes herewith an Attachment for Claim Amendments  
showing a marked up version of each amended claim.